IPC ASSOCIATION OF	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		der both le	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
upplier l	Information										_				
Company name*				Company unique ID			Unique ID Authority					Response Date*			
nsemi											2023-06-08				
Contact Nar	me		Title - Contact			P	Phone - Contact*				Email - Contact*				
?roduct-En	nv-Stewards		Product Enviro Compliance			ı	NA				Product-Env-Stewards@onsemi.com				
uthorized	Representative*	Title - Representative			P	Phone - Representative*			Email - Representative*						
Product-En	nv-Stewards		Product Enviro Compliance			ľ	NA				Product-Env-Stewards@onsemi.com				
]	Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	N	Innufacturing Site	Wei	ght*	UOM	Unit Type	
		LV5117AV-TLM-H 5-14 CELL LIB P		5-14 CELL LIB PR	OTECTION		2023-06-08 PHM		750	.0	mg	Each			
Ianufact	turing Proccess Inform	ation													
T	Terminal Plating / Grid Array Material Termin			rminal Base Alloy J-STD-020 MSL Rating		Rating	Peak Process Body Temperature Max Time at Peak			k Temperature Number of Reflow Cycles					
contains Bi		CU Alloy 3				260 C 30			seconds 3						
omments															
<u> TENTIO</u>	ON: MSL 3 Rated item requir	res Bake and D	ry Pack (after	r electrical test)											
or more in	formation regarding materia	al composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier shall apply the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	19.19	mg	Supplier	Silicon (Si)	7440-21-3		19.1094	mg
			Supplier	Polyimide	Proprietary Data		0.0806	mg
Die Attach	2.78	mg	Supplier	Silver (Ag)	7440-22-4		1.8915	mg
			Supplier	Epoxy resins	129915-35-1		0.804	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0606	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0239	mg
Lead Frame	186.12	mg	Supplier	Silver (Ag)	7440-22-4		0.4839	mg
			Supplier	Tin (Sn)	7440-31-5		0.4839	mg
			Supplier	Zinc (Zn)	7440-66-6		0.4653	mg
			Supplier	Chromium (Cr)	7440-47-3		0.5025	mg
			Supplier	Copper (Cu)	7440-50-8		184.1843	mg
Mold Compound-Black	531.51	mg		Epoxy Phenol Resin	proprietary data		63.7812	mg
			Supplier	Carbon Black (C)	1333-86-4		2.126	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		449.6574	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		15.9453	mg
Plating	9.5	mg	В	Bismuth (Bi)	7440-69-9		0.057	mg
			Supplier	Tin (Sn)	7440-31-5		9.443	mg
Wire Bond - Au	0.9	mg	Supplier	Gold (Au)	7440-57-5		0.9	mg